

VISHAY

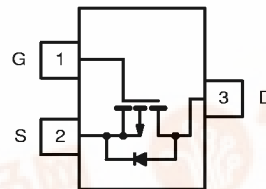
Si2301DS

Siliconix

P-Channel 1.25-W, 2.5-V MOSFET

PRODUCT SUMMARY

V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
-20	0.130 @ V _{GS} = -4.5 V	-2.3
	0.190 @ V _{GS} = -2.5 V	-1.9

TO-236
(SOT-23)

Top View

Si2301DS (A1)*

*Marking Code

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C UNLESS OTHERWISE NOTED)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	-20	V
Gate-Source Voltage	V _{GS}	±8	
Continuous Drain Current (T _J = 150°C) ^{NO TAG}	I _D	-2.3	A
		-1.5	
Pulsed Drain Current ^{NO TAG}	I _{DM}	-10	
Continuous Source Current (Diode Conduction) ^{NO TAG}	I _S	-1.6	
Power Dissipation ^{NO TAG}	P _D	1.25	W
		0.8	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Maximum Junction-to-Ambient ^{NO TAG}	R _{thJA}	100	°C/W
Maximum Junction-to-Ambient ^{NO TAG}		166	

Notes

- A. Pulse width limited by maximum junction temperature.
 B. Surface Mounted on FR4 Board, t ≤ 5 sec.
 C. Surface Mounted on FR4 Board.

Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70627.

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SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

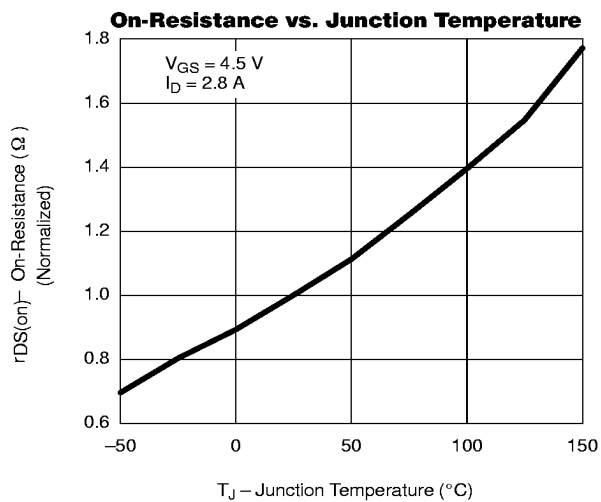
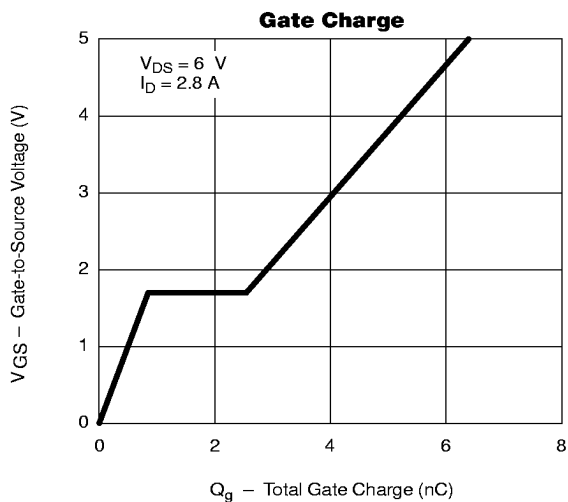
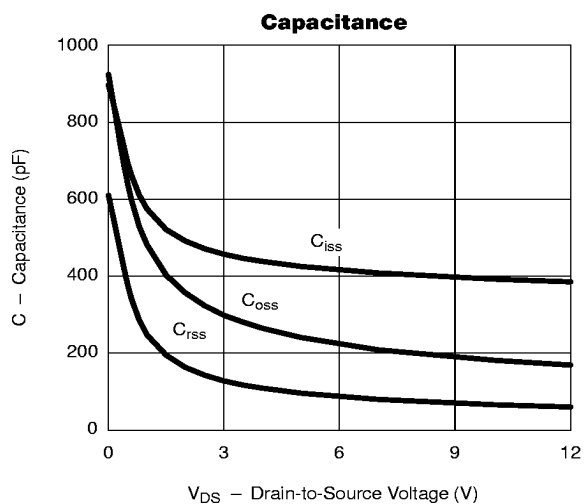
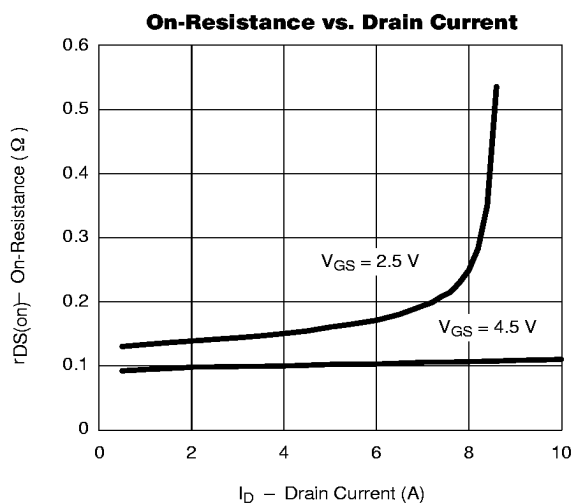
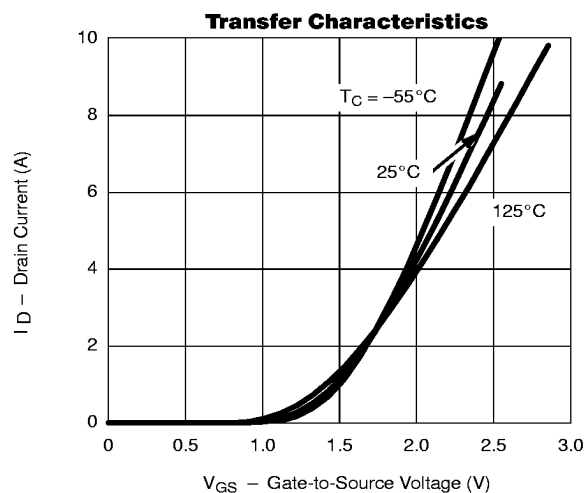
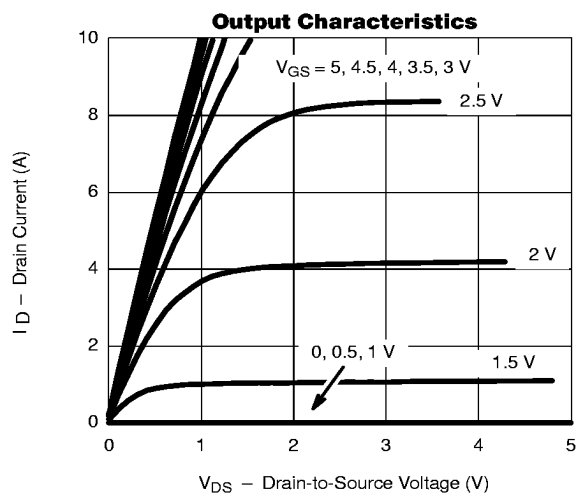
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$	-20			V
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$	-0.45			
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 8\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -16\text{ V}, V_{GS} = 0\text{ V}$			-1	μA
		$T_J = 55^\circ\text{C}$			-10	
On-State Drain Current ^{NO TAG}	$I_{D(on)}$	$V_{DS} \leq -5\text{ V}, V_{GS} = -4.5\text{ V}$	-6			A
		$V_{DS} \leq -5\text{ V}, V_{GS} = -2.5\text{ V}$	-3			
Drain-Source On-Resistance ^{NO TAG}	$r_{DS(on)}$	$V_{GS} = -4.5\text{ V}, I_D = -2.8\text{ A}$		0.105	0.130	Ω
		$V_{GS} = -2.5\text{ V}, I_D = -2.0\text{ A}$		0.145	0.190	
Forward Transconductance ^{NO TAG}	g_{fs}	$V_{DS} = -5\text{ V}, I_D = -2.8\text{ A}$		6.5		S
Diode Forward Voltage	V_{SD}	$I_S = -1.6\text{ A}, V_{GS} = 0\text{ V}$		0.80	-1.2	V
DYNAMIC ^{NO TAG}						
Total Gate Charge	Q_g	$V_{DS} = -6\text{ V}, V_{GS} = -4.5\text{ V}$ $I_D \cong -2.8\text{ A}$		5.8	10	nC
Gate-Source Charge	Q_{gs}			0.85		
Gate-Drain Charge	Q_{gd}			1.70		
Input Capacitance	C_{iss}	$V_{DS} = -6\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$		415		pF
Output Capacitance	C_{oss}			223		
Reverse Transfer Capacitance	C_{rss}			87		
SWITCHING ^{NO TAG}						
Turn-On Time	$t_{d(on)}$	$V_{DD} = -6\text{ V}, R_L = 6\text{ }\Omega$ $I_D \cong -1.0\text{ A}, V_{GEN} = -4.5\text{ V}$ $R_G = 6\text{ }\Omega$		13.0	25	ns
	t_r			36.0	60	
Turn-Off Time	$t_{d(off)}$			42	70	
	t_f			34	60	

Notes

- A. For DESIGN AID ONLY, not subject to production testing.
- B. Pulse test: $PW \leq 300\text{ }\mu\text{s}$ duty cycle $\leq 2\%$.
- C. Switching time is essentially independent of operating temperature.



TYPICAL CHARACTERISTICS (25°C UNLESS OTHERWISE NOTED)



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